

# MGP15N40CL, MGB15N40CL

Preferred Device

## Ignition IGBT 15 Amps, 410 Volts N-Channel TO-220 and D2PAK

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over-Voltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

- Ideal for Coil-On-Plug, IGBT-On-Coil, or Distributorless Ignition System Applications
- High Pulsed Current Capability up to 50 A
- Gate-Emitter ESD Protection
- Temperature Compensated Gate-Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- Low Threshold Voltage to Interface Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- Optional Gate Resistor ( $R_G$ )

### MAXIMUM RATINGS ( $-55^{\circ}\text{C} \leq T_J \leq 175^{\circ}\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CES}$	440	$V_{DC}$
Collector-Gate Voltage	$V_{CER}$	440	$V_{DC}$
Gate-Emitter Voltage	$V_{GE}$	22	$V_{DC}$
Collector Current-Continuous @ $T_C = 25^{\circ}\text{C}$ - Pulsed	$I_C$	15 50	$A_{DC}$ $A_{AC}$
ESD (Human Body Model) $R = 1500 \Omega$ , $C = 100 \text{ pF}$	ESD	8.0	kV
ESD (Machine Model) $R = 0 \Omega$ , $C = 200 \text{ pF}$	ESD	800	V
Total Power Dissipation @ $T_C = 25^{\circ}\text{C}$ Derate above $25^{\circ}\text{C}$	$P_D$	150 1.0	Watts $\text{W}/^{\circ}\text{C}$
Operating and Storage Temperature Range	$T_J, T_{stg}$	-55 to 175	$^{\circ}\text{C}$

### UNCLAMPED COLLECTOR-TO-EMITTER AVALANCHE CHARACTERISTICS ( $-55^{\circ}\text{C} \leq T_J \leq 175^{\circ}\text{C}$ )

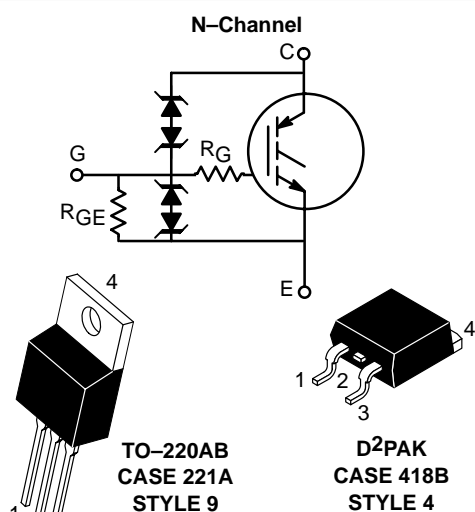
Characteristic	Symbol	Value	Unit
Single Pulse Collector-to-Emitter Avalanche Energy $V_{CC} = 50 \text{ V}$ , $V_{GE} = 5.0 \text{ V}$ , Pk $I_L = 17.4 \text{ A}$ , $L = 2.0 \text{ mH}$ , Starting $T_J = 25^{\circ}\text{C}$ $V_{CC} = 50 \text{ V}$ , $V_{GE} = 5.0 \text{ V}$ , Pk $I_L = 14.2 \text{ A}$ , $L = 2.0 \text{ mH}$ , Starting $T_J = 150^{\circ}\text{C}$	$E_{AS}$	300 200	mJ
Reverse Avalanche Energy $V_{CC} = 100 \text{ V}$ , $V_{GE} = 20 \text{ V}$ , $L = 3.0 \text{ mH}$ , Pk $I_L = 25.8 \text{ A}$ , Starting $T_J = 25^{\circ}\text{C}$	$E_{AS(R)}$	1000	mJ



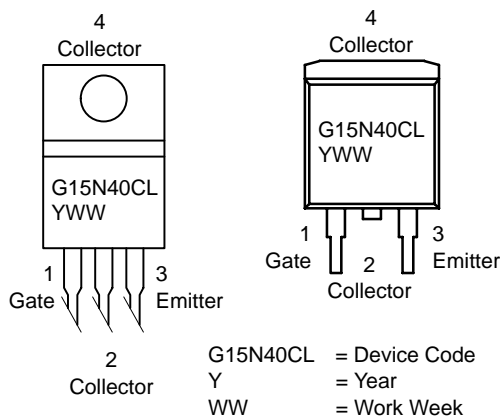
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**15 AMPERES**  
**410 VOLTS (Clamped)**  
 **$V_{CE(on)} @ 10 \text{ A} = 1.8 \text{ V Max}$**



### MARKING DIAGRAMS & PIN ASSIGNMENTS



### ORDERING INFORMATION

Device	Package	Shipping
MGP15N40CL	TO-220	50 Units/Rail
MGB15N40CLT4	D2PAK	800 Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

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## THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	°C/W
Thermal Resistance, Junction to Ambient	TO-220 $R_{\theta JA}$	62.5	
	D <sup>2</sup> PAK (Note 1) $R_{\theta JA}$	50	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	$T_L$	275	°C

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Temperature	Min	Typ	Max	Unit
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## OFF CHARACTERISTICS

Collector–Emitter Clamp Voltage	$BV_{CES}$	$I_C = 2.0 \text{ mA}$	$T_J = -40^\circ\text{C to } 150^\circ\text{C}$	380	410	440	$V_{DC}$
		$I_C = 10 \text{ mA}$	$T_J = -40^\circ\text{C to } 150^\circ\text{C}$	390	420	450	
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{CE} = 350 \text{ V},$ $V_{GE} = 0 \text{ V}$	$T_J = 25^\circ\text{C}$	–	1.5	20	$\mu\text{A}_{DC}$
			$T_J = 150^\circ\text{C}$	–	10	40*	
			$T_J = -40^\circ\text{C}$	–	0.7	1.5	
Reverse Collector–Emitter Leakage Current	$I_{ECS}$	$V_{CE} = -24 \text{ V}$	$T_J = 25^\circ\text{C}$	–	0.35	1.0	mA
			$T_J = 150^\circ\text{C}$	–	8.0	15*	
			$T_J = -40^\circ\text{C}$	–	0.05	0.5	
Reverse Collector–Emitter Clamp Voltage	$BV_{CES(R)}$	$I_C = -75 \text{ mA}$	$T_J = 25^\circ\text{C}$	25	33	50	$V_{DC}$
			$T_J = 150^\circ\text{C}$	25	36	50	
			$T_J = -40^\circ\text{C}$	25	30	50	
Gate–Emitter Clamp Voltage	$BV_{GES}$	$I_G = 5.0 \text{ mA}$	$T_J = -40^\circ\text{C to } 150^\circ\text{C}$	17	20	22	$V_{DC}$
Gate–Emitter Leakage Current	$I_{GES}$	$V_{GE} = 10 \text{ V}$	$T_J = -40^\circ\text{C to } 150^\circ\text{C}$	384	600	1000	$\mu\text{A}_{DC}$
Gate Resistor (Optional)	$R_G$	–	$T_J = -40^\circ\text{C to } 150^\circ\text{C}$	–	70	–	$\Omega$
Gate Emitter Resistor	$R_{GE}$	–	$T_J = -40^\circ\text{C to } 150^\circ\text{C}$	10	16	26	k $\Omega$

## ON CHARACTERISTICS (Note 2)

Gate Threshold Voltage	$V_{GE(th)}$	$I_C = 1.0 \text{ mA},$ $V_{GE} = V_{CE}$	$T_J = 25^\circ\text{C}$	1.4	1.7	2.0	$V_{DC}$
			$T_J = 150^\circ\text{C}$	0.75	1.1	1.4	
			$T_J = -40^\circ\text{C}$	1.6	1.9	2.1*	
Threshold Temperature Coefficient (Negative)	–	–	–	–	4.4	–	mV/°C

1. When surface mounted to an FR4 board using the minimum recommended pad size.

2. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

\*Maximum Value of Characteristic across Temperature Range.

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## ELECTRICAL CHARACTERISTICS (continued)

Characteristic	Symbol	Test Conditions	Temperature	Min	Typ	Max	Unit
<b>ON CHARACTERISTICS (continued)</b> (Note 3)							
Collector-to-Emitter On-Voltage	$V_{CE(on)}$	$I_C = 6.0 \text{ A}$ , $V_{GE} = 4.0 \text{ V}$	$T_J = 25^\circ\text{C}$	1.0	1.3	1.6	V <sub>DC</sub>
			$T_J = 150^\circ\text{C}$	0.9	1.2	1.5	
			$T_J = -40^\circ\text{C}$	1.1	1.4	1.7*	
		$I_C = 10 \text{ A}$ , $V_{GE} = 4.0 \text{ V}$	$T_J = 25^\circ\text{C}$	1.3	1.6	1.9	
			$T_J = 150^\circ\text{C}$	1.2	1.5	1.8	
			$T_J = -40^\circ\text{C}$	1.3	1.6	1.9*	
		$I_C = 15 \text{ A}$ , $V_{GE} = 4.0 \text{ V}$	$T_J = 25^\circ\text{C}$	1.6	1.95	2.25	
			$T_J = 150^\circ\text{C}$	1.7	2.0	2.3*	
			$T_J = -40^\circ\text{C}$	1.6	1.9	2.2	
		$I_C = 20 \text{ A}$ , $V_{GE} = 4.0 \text{ V}$	$T_J = 25^\circ\text{C}$	1.9	2.2	2.5	
			$T_J = 150^\circ\text{C}$	2.1	2.4	2.7*	
			$T_J = -40^\circ\text{C}$	1.85	2.15	2.45	
$I_C = 25 \text{ A}$ , $V_{GE} = 4.0 \text{ V}$	$T_J = 25^\circ\text{C}$	2.1	2.5	2.9			
	$T_J = 150^\circ\text{C}$	2.5	2.9	3.3*			
	$T_J = -40^\circ\text{C}$	2.0	2.4	2.8			
Collector-to-Emitter On-Voltage	$V_{CE(on)}$	$I_C = 10 \text{ A}$ , $V_{GE} = 4.5 \text{ V}$	$T_J = 150^\circ\text{C}$	–	1.5	1.8	V <sub>DC</sub>
Forward Transconductance	gfs	$V_{CE} = 5.0 \text{ V}$ , $I_C = 6.0 \text{ A}$	$T_J = -40^\circ\text{C}$ to $150^\circ\text{C}$	8.0	15	25	Mhos

## DYNAMIC CHARACTERISTICS

Input Capacitance	$C_{ISS}$	$V_{CC} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ $f = 1.0 \text{ MHz}$	$T_J = -40^\circ\text{C}$ to $150^\circ\text{C}$	–	1000	1300	pF
Output Capacitance	$C_{OSS}$			–	100	130	
Transfer Capacitance	$C_{RSS}$			–	5.0	8.0	

## SWITCHING CHARACTERISTICS (Note 3)

Turn-Off Delay Time (Inductive)	$t_{d(off)}$	$V_{CC} = 300 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $L = 300 \mu\text{H}$	$T_J = 25^\circ\text{C}$	–	4.0	10	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	4.5	10	
Fall Time (Inductive)	$t_f$	$V_{CC} = 300 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $L = 300 \mu\text{H}$	$T_J = 25^\circ\text{C}$	–	7.0	10	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	10	15*	
Turn-Off Delay Time (Resistive)	$t_{d(off)}$	$V_{CC} = 300 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $R_L = 46 \Omega$	$T_J = 25^\circ\text{C}$	–	4.0	10	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	4.5	10	
Fall Time (Resistive)	$t_f$	$V_{CC} = 300 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $R_L = 46 \Omega$	$T_J = 25^\circ\text{C}$	–	13	20	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	16	20	
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 10 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $R_L = 1.5 \Omega$	$T_J = 25^\circ\text{C}$	–	1.0	1.5	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	1.0	1.5	
Rise Time	$t_r$	$V_{CC} = 10 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $R_L = 1.5 \Omega$	$T_J = 25^\circ\text{C}$	–	4.5	6.0	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	5.0	6.0	

3. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

\*Maximum Value of Characteristic across Temperature Range.

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## TYPICAL ELECTRICAL CHARACTERISTICS (unless otherwise noted)

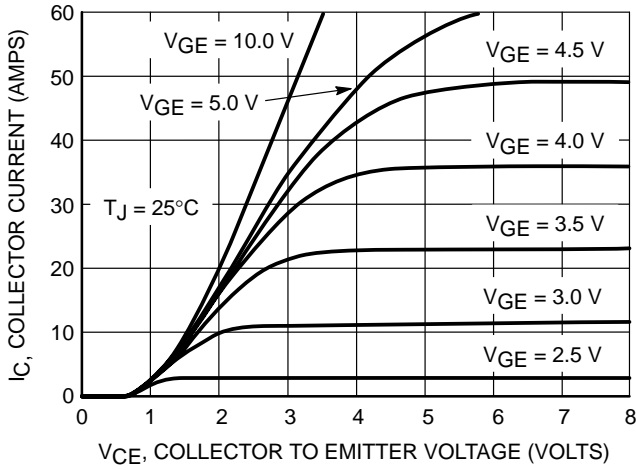


Figure 1. Output Characteristics

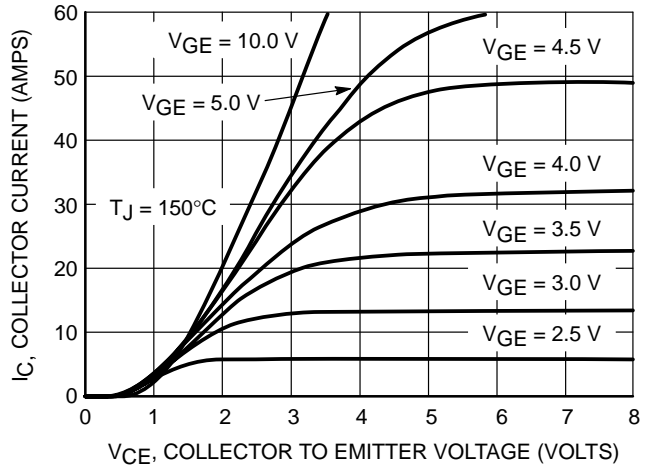


Figure 2. Output Characteristics

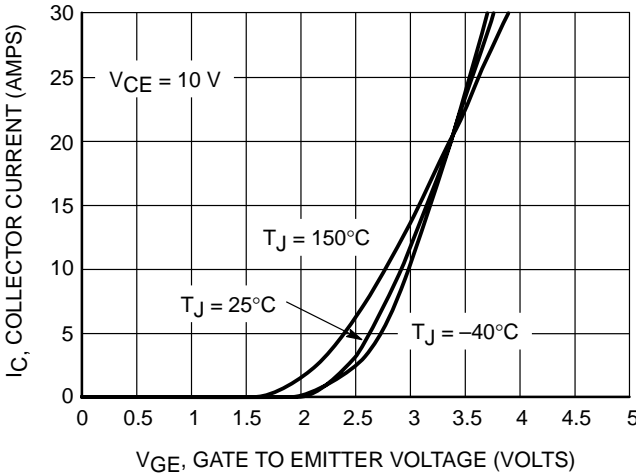


Figure 3. Transfer Characteristics

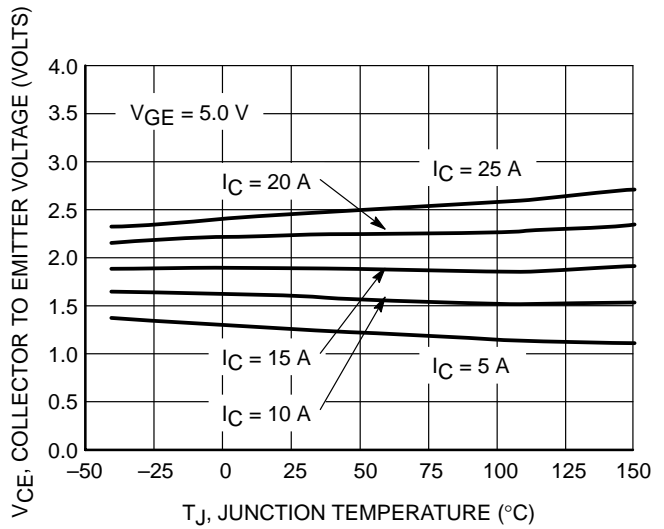


Figure 4. Collector-to-Emitter Saturation Voltage vs. Junction Temperature

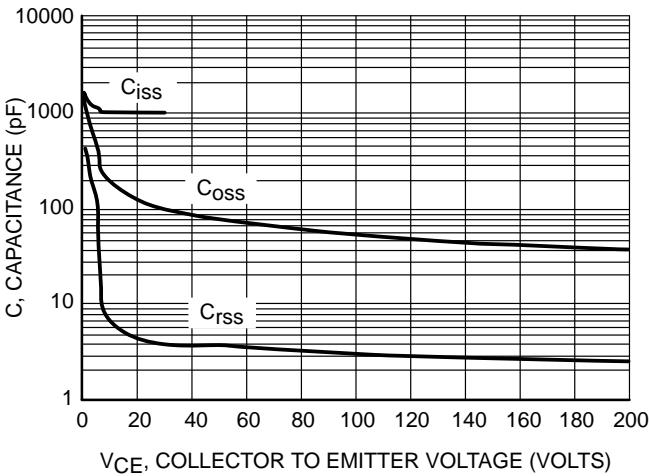


Figure 5. Capacitance Variation

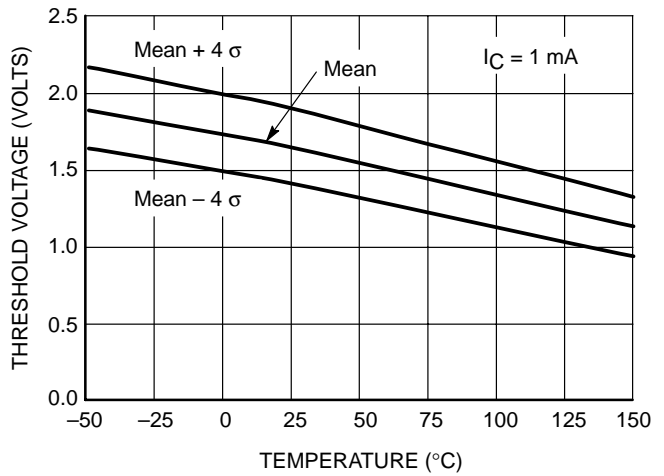
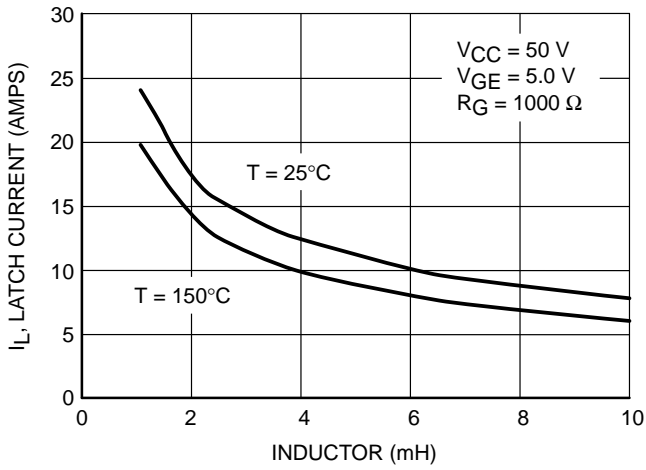
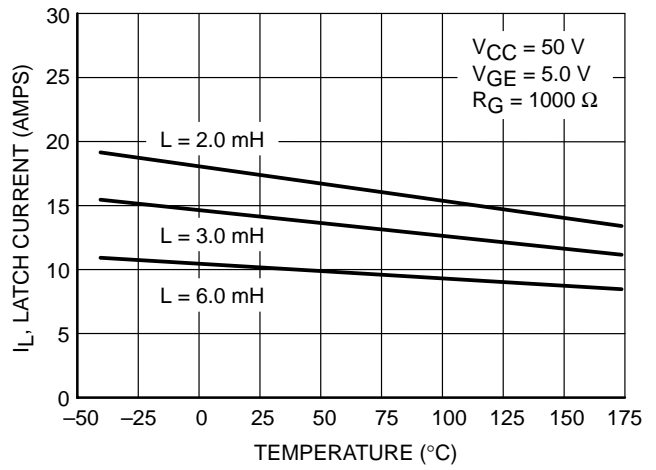


Figure 6. Threshold Voltage vs. Temperature

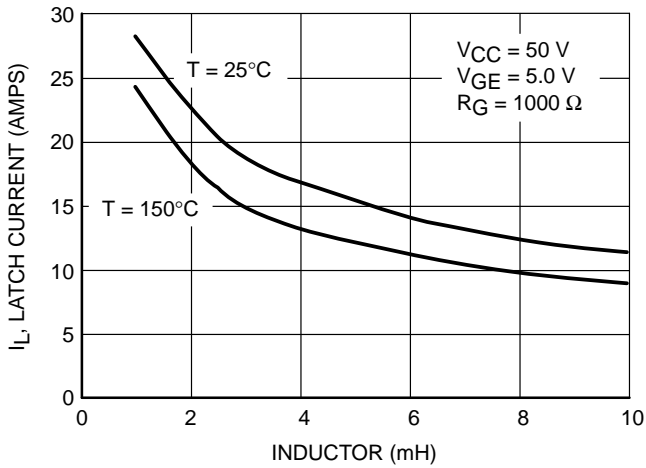
# MGP15N40CL, MGB15N40CL



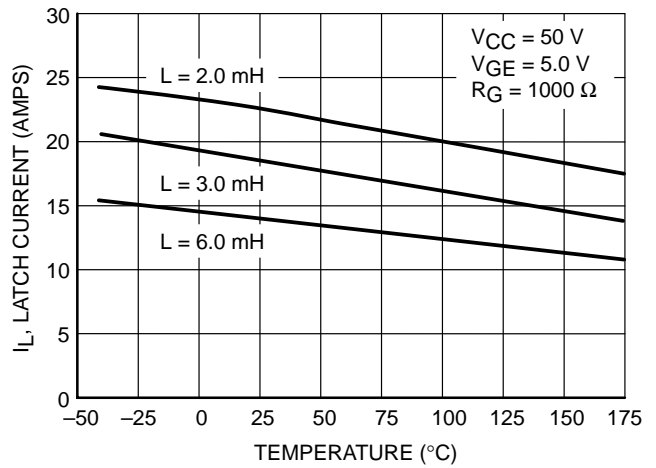
**Figure 7. Minimum Open Secondary Latch Current vs. Inductor**



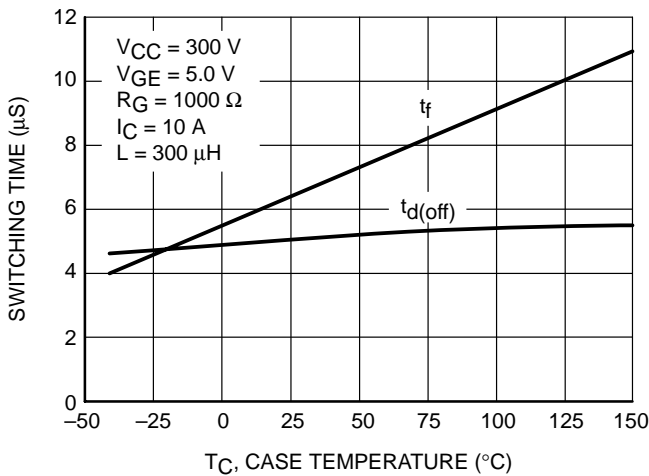
**Figure 8. Minimum Open Secondary Latch Current vs. Temperature**



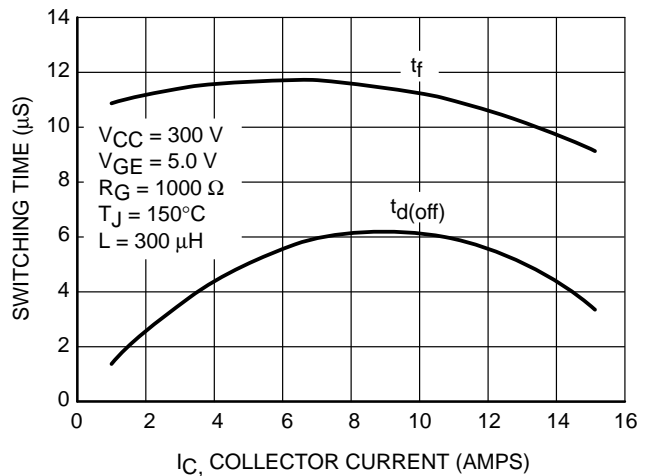
**Figure 9. Typical Open Secondary Latch Current vs. Inductor**



**Figure 10. Typical Open Secondary Latch Current vs. Temperature**

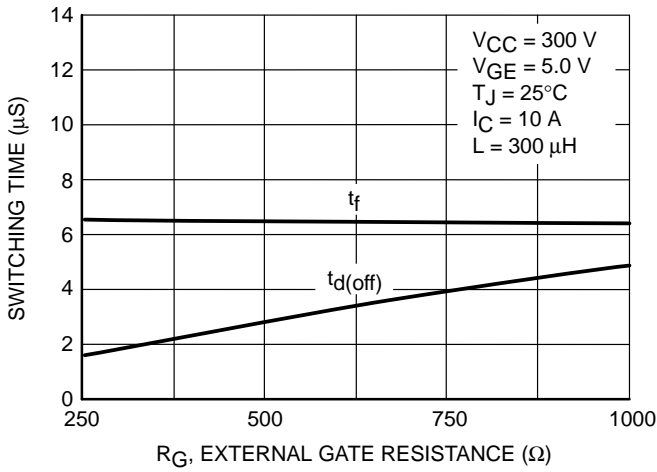


**Figure 11. Switching Speed vs. Case Temperature**

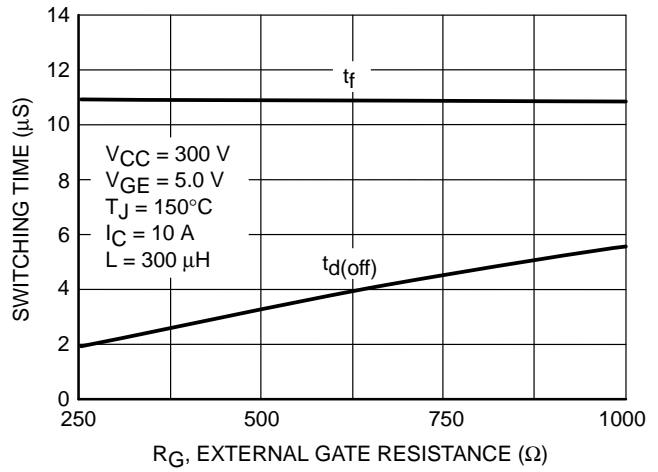


**Figure 12. Switching Speed vs. Collector Current**

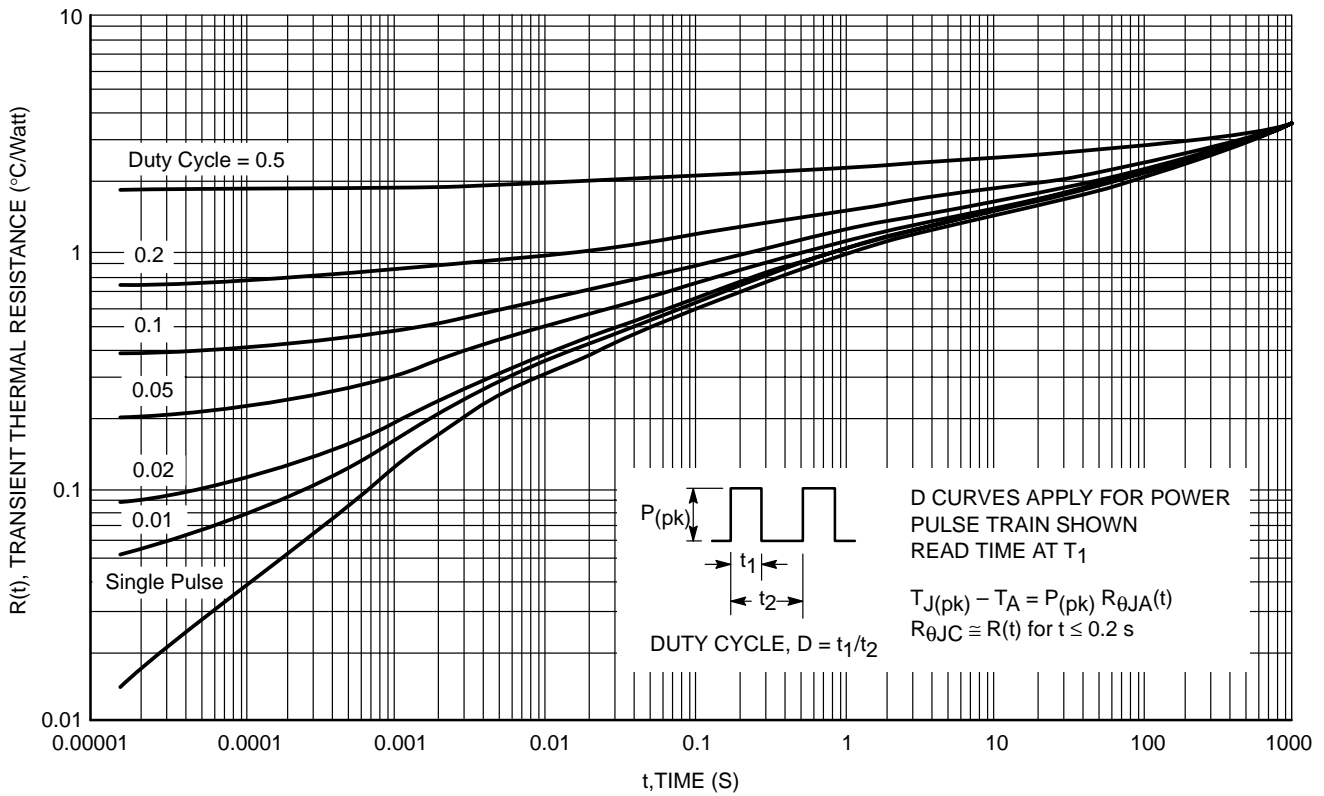
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**Figure 13. Switching Speed vs. External Gate Resistance**

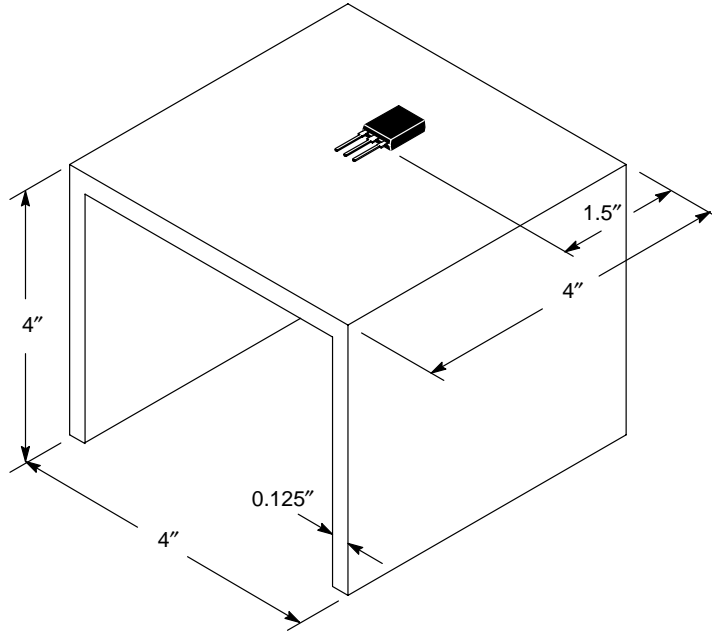


**Figure 14. Switching Speed vs. External Gate Resistance**

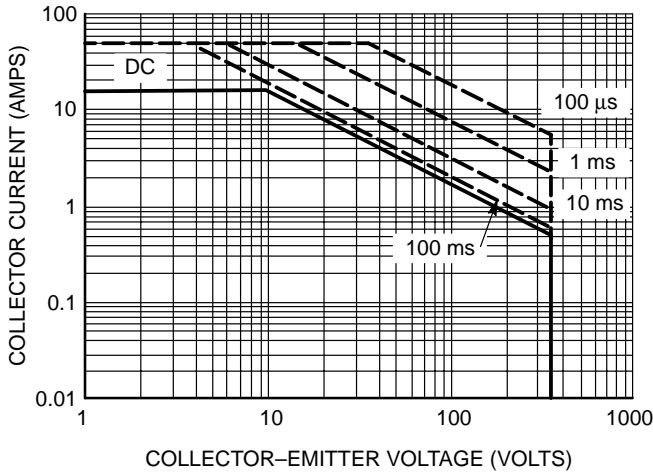


**Figure 15. Transient Thermal Resistance (Non-normalized Junction-to-Ambient mounted on fixture in Figure 16)**

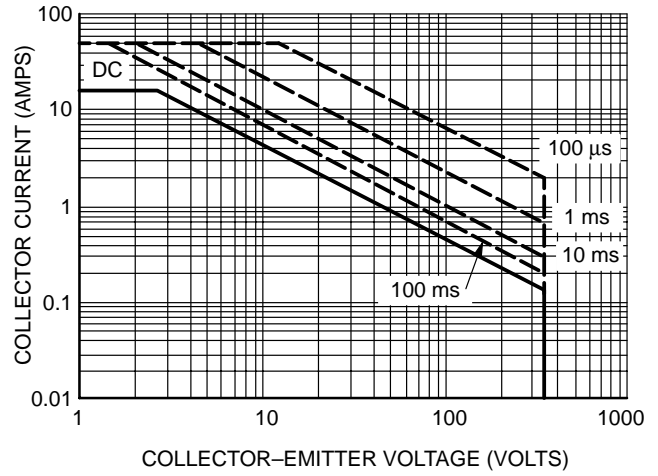
# MGP15N40CL, MGB15N40CL



**Figure 16. Test Fixture for Transient Thermal Curve  
(48 square inches of 1/8" thick aluminum)**

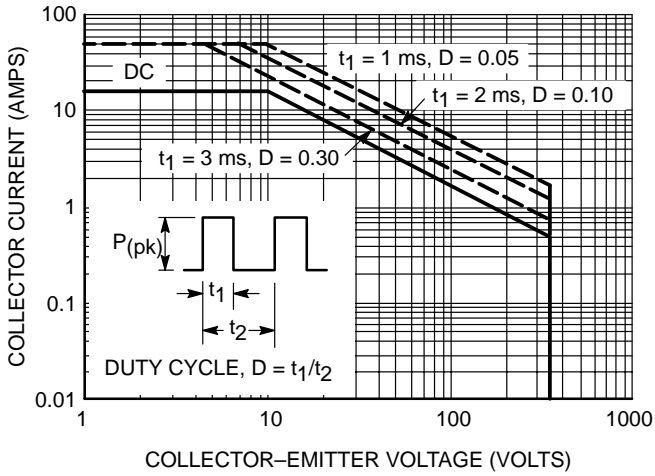


**Figure 17. Single Pulse Safe Operating Area  
(Mounted on an Infinite Heatsink at  $T_C = 25^\circ\text{C}$ )**

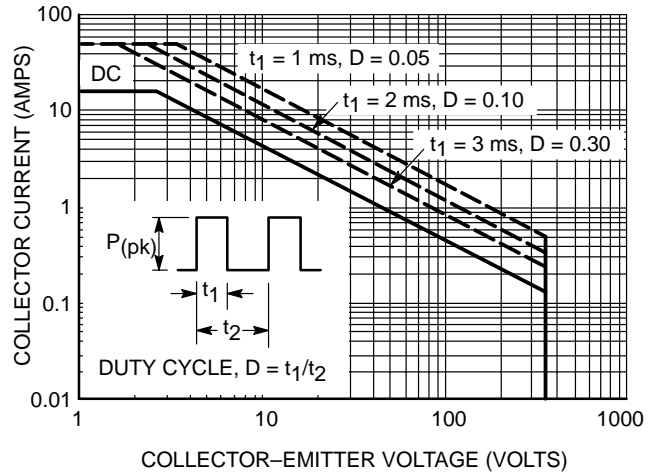


**Figure 18. Single Pulse Safe Operating Area  
(Mounted on an Infinite Heatsink at  $T_C = 125^\circ\text{C}$ )**

# MGP15N40CL, MGB15N40CL



**Figure 19. Pulse Train Safe Operating Area (Mounted on an Infinite Heatsink at  $T_C = 25^\circ\text{C}$ )**



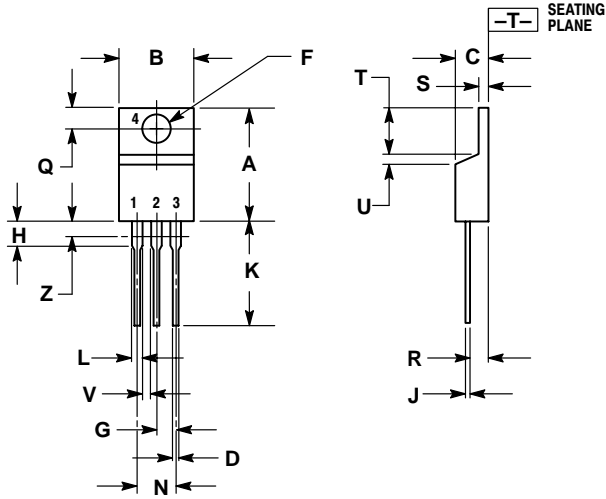
**Figure 20. Pulse Train Safe Operating Area (Mounted on an Infinite Heatsink at  $T_C = 125^\circ\text{C}$ )**



# MGP15N40CL, MGB15N40CL

## PACKAGE DIMENSIONS

TO-220 THREE-LEAD  
TO-220AB  
CASE 221A-09  
ISSUE AA



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

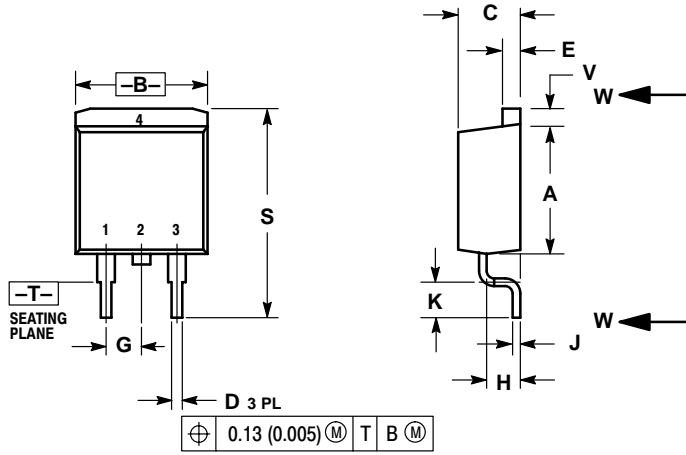
STYLE 9:

- PIN 1. GATE
- COLLECTOR
- EMITTER
- COLLECTOR

# MGP15N40CL, MGB15N40CL

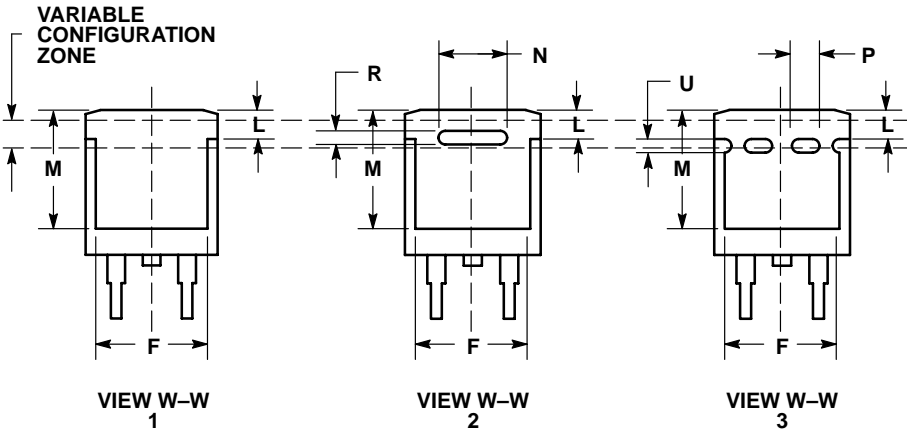
## PACKAGE DIMENSIONS

D2PAK  
CASE 418B-04  
ISSUE G



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.340	0.380	8.64	9.65
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100 BSC		2.54 BSC	
H	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
M	0.280	0.320	7.11	8.13
N	0.197 REF		5.00 REF	
P	0.079 REF		2.00 REF	
R	0.039 REF		0.99 REF	
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40



- STYLE 4:  
PIN 1. GATE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR

## Notes

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